

**FEATURES** 

- 2-V to 5.5-V V<sub>CC</sub> Operation
- Max t<sub>pd</sub> of 10 ns at 5 V
- Typical V<sub>OLP</sub> (Output Ground Bounce) <0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot) >2.3 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Support Mixed-Mode Voltage Operation on All Ports
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

| SN54LV14AJ OR W PACKAGE   | SN74LV14ARGY PACKAGE                                  | SN54LV14AFK PACKAGE  |  |  |  |
|---|---|--|--|--|--|
| SN74LV14AD, DB, DGV, NS   | (TOP VIEW)  | (TOP VIEW)   |  |  |  |
| OR PW PACKAGE<br>(TOP VIEW)<br>1A [ 1 14 ] V <sub>CC</sub><br>1Y [ 2 13 ] 6A<br>2A [ 3 12 ] 6Y<br>2Y [ 4 11 ] 5A<br>3A [ 5 10 ] 5Y<br>3Y [ 6 9 ] 4A<br>GND [ 7 8 ] 4Y | $ \begin{array}{cccccccccccccccccccccccccccccccccccc$ | $\begin{array}{c} \begin{array}{c} \begin{array}{c} \begin{array}{c} \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} $ |  |  |  |

### **DESCRIPTION/ORDERING INFORMATION**

These hex Schmitt-trigger inverters are designed for 2-V to 5.5-V  $V_{CC}$  operation.

The 'LV14A devices contain six independent inverters. These devices perform the Boolean function  $Y = \overline{A}$ .

These devices are fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

| T <sub>A</sub> | PACI        | KAGE <sup>(1)(2)</sup> | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-------------|------------------------|-----------------------|------------------|
|                | QFN – RGY   | Reel of 1000           | SN74LV14ARGYR         | LV14A            |
|                | 0010 D      | Tube of 50             | SN74LV14AD            |                  |
| -40°C to 85°C  | SOIC – D    | Reel of 2500           | SN74LV14ADR           | LV14A            |
|                | SOP – NS    | Reel of 2000           | SN74LV14ANSR          | 74LV14A          |
|                | SSOP – DB   | Reel of 2000           | SN74LV14ADBR          | LV14A            |
|                |             | Tube of 90             | SN74LV14APW           |                  |
|                | TSSOP – PW  | Reel of 2000           | SN74LV14APWR          | LV14A            |
|                |             | Reel of 250            | SN74LV14APWT          |                  |
|                | TVSOP – DGV | Reel of 2000           | SN74LV14ADGVR         | LV14A            |
|                | CDIP – J    | Tube of 25             | SNJ54LV14AJ           | SNJ54LV14AJ      |
| -55°C to 125°C | CFP – W     | Tube of 150            | SNJ54LV14AW           | SNJ54LV14AW      |
|                | LCCC – FK   | Tube of 55             | SNJ54LV14AFK          | SNJ54LV14AFK     |

### **ORDERING INFORMATION**

(1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



# FUNCTION TABLE (each inverter)

| INPUT<br>A | OUTPUT<br>Y |
|------------|-------------|
| Н          | L           |
| L          | Н           |

### LOGIC DIAGRAM, EACH INVERTER (POSITIVE LOGIC)



### ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |  |  | MIN                   | MAX | UNIT  |
|------------------|--|--|-----------------------|-----|-------|
| $V_{CC}$         | Supply voltage range                       |  | -0.5                  | 7   | V     |
| VI               | Input voltage range <sup>(2)</sup>         |  | -0.5                  | 7   | V     |
| Vo               | Voltage range applied to any output in the | high-impedance or power-off state <sup>(2)</sup> | -0.5                  | 7   | V     |
| Vo               | Output voltage range <sup>(2)(3)</sup>     | -0.5   | V <sub>CC</sub> + 0.5 | V   |       |
| I <sub>IK</sub>  | Input clamp current                        | V <sub>I</sub> < 0                               |                       | -20 | mA    |
| I <sub>OK</sub>  | Output clamp current                       | V <sub>O</sub> < 0                               |                       | -50 | mA    |
| lo               | Continuous output current                  | $V_{O} = 0$ to $V_{CC}$                          |                       | ±25 | mA    |
|                  | Continuous current through $V_{CC}$ or GND |  |                       | ±50 | mA    |
|                  |  | D package <sup>(4)</sup>                         |                       | 86  |       |
|                  |  | DB package <sup>(4)</sup>                        |                       | 96  |       |
| 0                | Deckage thermal impedance                  | DGV package <sup>(4)</sup>                       |                       | 127 | 00 11 |
| $\theta_{JA}$    | Package thermal impedance                  | NS package <sup>(4)</sup>                        |                       | 76  | °C/W  |
|                  |  | PW package <sup>(4)</sup>                        |                       | 113 |       |
|                  |  | RGY package <sup>(5)</sup>                       |                       | 47  |       |
| T <sub>stg</sub> | Storage temperature range                  |  | -65                   | 150 | °C    |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) This value is limited to 5.5 V maximum.

(4) The package thermal impedance is calculated in accordance with JESD 51-7

(5) The package thermal impedance is calculated in accordance with JESD 51-5.



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### **RECOMMENDED OPERATING CONDITIONS**<sup>(1)</sup>

|                 |                                |                                    | SN54LV1 | 4A <sup>(2)</sup> | SN74LV | 14A             | UNIT |
|-----------------|--------------------------------|------------------------------------|---------|-------------------|--------|-----------------|------|
|                 |                                |                                    | MIN     | MAX               | MIN    | MAX             | UNIT |
| $V_{CC}$        | Supply voltage                 |                                    | 2       | 5.5               | 2      | 5.5             | V    |
| VI              | Input voltage                  |                                    | 0       | 5.5               | 0      | 5.5             | V    |
| Vo              | Output voltage                 |                                    | 0       | V <sub>CC</sub>   | 0      | V <sub>CC</sub> | V    |
|                 | High-level output current      | $V_{CC} = 2 V$                     |         | -50               |        | -50             | μA   |
|                 |                                | $V_{CC}$ = 2.3 V to 2.7 V          |         | -2                |        | -2              |      |
| IOH             |                                | $V_{CC} = 3 V \text{ to } 3.6 V$   |         | -6                |        | -6              | mA   |
|                 |                                | $V_{CC}$ = 4.5 V to 5.5 V          |         | -12               |        | -12             |      |
|                 |                                | $V_{CC} = 2 V$                     |         | 50                |        | 50              | μA   |
|                 | Law law law and a summary      | $V_{CC}$ = 2.3 V to 2.7 V          |         | 2                 |        | 2               |      |
| I <sub>OL</sub> | Low-level output current       | $V_{CC} = 3 V \text{ to } 3.6 V$   |         | 6                 |        | 6               | mA   |
|                 |                                | $V_{CC} = 4.5 V \text{ to } 5.5 V$ |         | 12                |        | 12              |      |
| T <sub>A</sub>  | Operating free-air temperature | · · · ·                            | -55     | 125               | -40    | 85              | °C   |

 All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

(2) Product Preview

### **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED           | TEST CONDITIONS                                    | V               | SN54L                 | V14A <sup>(1)</sup> | SN74           | LV14A   | UNIT |     |
|---------------------|--|-----------------|-----------------------|---------------------|----------------|---------|------|-----|
| PARAMETER           | TEST CONDITIONS                                    | V <sub>cc</sub> | MIN                   | TYP MAX             | MIN            | TYP MAX | UNIT |     |
| V <sub>T+</sub>     |  | 2.5 V           |                       | 1.75                |                | 1.75    |      |     |
| Positive-going      |  | 3.3 V           |                       | 2.31                |                | 2.31    | V    |     |
| threshold           |  | 5 V             |                       | 3.5                 |                | 3.5     |      |     |
| V <sub>T-</sub>     |  | 2.5 V           | 0.75                  |                     | 0.75           |         |      |     |
| Negative-going      |  | 3.3 V           | 0.99                  |                     | 0.99           |         | V    |     |
| threshold           |  | 5 V             | 1.5                   |                     | 1.5            |         |      |     |
| ΔV <sub>T</sub>     |  | 2.5 V           | 0.25                  |                     | 0.25           |         |      |     |
| Hysteresis          |  | 3.3 V           | 0.33                  |                     | 0.33           |         | V    |     |
| $(V_{T+} - V_{T-})$ |  | 5 V             | 0.5                   |                     | 0.5            |         |      |     |
|                     | I <sub>OH</sub> = -50 μA                           | 2 V to 5.5 V    | V <sub>CC</sub> - 0.1 |                     | $V_{CC} - 0.1$ |         |      |     |
| V                   | I <sub>OH</sub> = -2 mA                            | 2.3 V           | 2                     |                     | 2              |         | v    |     |
| V <sub>OH</sub>     | I <sub>OH</sub> = -6 mA                            | 3 V             | 2.48                  |                     | 2.48           |         | v    |     |
|                     | I <sub>OH</sub> = -12 mA                           | 4.5 V           | 3.8                   |                     | 3.8            |         |      |     |
|                     | I <sub>OL</sub> = 50 μA                            | 2 V to 5.5 V    |                       | 0.1                 |                | 0.1     |      |     |
| V <sub>OL</sub>     | I <sub>OL</sub> = 2 mA                             | 2.3 V           |                       | 0.4                 |                | 0.4     | v    |     |
| V OL                | I <sub>OL</sub> = 6 mA                             | 3 V             |                       | 0.44                |                | 0.44    | v    |     |
|                     | I <sub>OL</sub> = 12 mA                            | 4.5 V           |                       | 0.55                |                | 0.55    |      |     |
| l <sub>l</sub>      | $V_I = V_{CC}$ or GND                              | 0 to 5.5 V      |                       | ±1                  |                | ±1      | μA   |     |
| I <sub>CC</sub>     | $V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$ | 5.5 V           |                       | 20                  |                | 20      | μA   |     |
| l <sub>off</sub>    | $V_{I}$ or $V_{O}$ = 0 to 5.5 V                    | 0               |                       | 5                   |                | 5       | μA   |     |
| C                   |  |                 | 3.3 V                 |                     | 2.3            |         | 2.3  | 5 F |
| Ci                  | $V_{I} = V_{CC} \text{ or } GND$                   | 5 V             |                       | 2.3                 |                | 2.3     | pF   |     |

(1) Product Preview

# SN54LV14A, SN74LV14A HEX SCHMITT-TRIGGER INVERTERS

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### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V<sub>CC</sub> = 2.5 V ± 0.2 V (unless otherwise noted) (see Figure 1)

| PARAMETER   | FROM    | то       | LOAD<br>CAPACITANCE    |     | T <sub>A</sub> = 25°C |                     | SN54LV14A <sup>(1)</sup> |                   | SN74LV14A |     | UNIT |
|-------------|---------|----------|------------------------|-----|-----------------------|---------------------|--------------------------|-------------------|-----------|-----|------|
| FARAIVIETER | (INPUT) | (OUTPUT) |                        | MIN | TYP                   | MAX                 | MIN                      | MAX               | MIN       | MAX | UNIT |
|             | ٥       | V        | C <sub>L</sub> = 15 pF |     | 10.2 <sup>(2)</sup>   | 19.7 <sup>(2)</sup> | 1 <sup>(2)</sup>         | 22 <sup>(2)</sup> | 1         | 22  |      |
| чрd         | A       | ř        | C <sub>L</sub> = 50 pF |     | 13.3                  | 24                  | 1                        | 27                | 1         | 27  | ns   |

(1) Product Preview

(2) On products compliant to MIL-PRF-38535, this parameter is not production tested.

### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM             | то          | LOAD                   |     | T <sub>A</sub> = 25°C |                     |                  | SN54LV14A <sup>(1)</sup> |     | SN74LV14A |    |
|-----------|------------------|-------------|------------------------|-----|-----------------------|---------------------|------------------|--------------------------|-----|-----------|----|
| FARAMETER | (INPUT) (OUTPUT) | CAPACITANCE | MIN                    | TYP | MAX                   | MIN                 | MAX              | MIN                      | MAX | UNIT      |    |
| +         | ٨                | v           | C <sub>L</sub> = 15 pF |     | 7.3 <sup>(2)</sup>    | 12.8 <sup>(2)</sup> | 1 <sup>(2)</sup> | 15.9 <sup>(2)</sup>      | 1   | 15        | 20 |
| ۲pd       | A                | T           | C <sub>L</sub> = 50 pF |     | 9.6                   | 16.3                | 1                | 19.4                     | 1   | 18.5      | ns |

(1) Product Preview

(2) On products compliant to MIL-PRF-38535, this parameter is not production tested.

### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CC} = 5 V \pm 0.5 V$  (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM             | то          | D LOAD                 | T <sub>A</sub> = 25°C  |     |                    | SN54LV14A <sup>(1)</sup> |                  | SN74LV14A         |      |    |  |
|-----------|------------------|-------------|------------------------|------------------------|-----|--------------------|--------------------------|------------------|-------------------|------|----|--|
| PARAMETER | (INPUT) (OUTPUT) | CAPACITANCE | MIN                    | TYP                    | MAX | MIN                | MAX                      | MIN              | MAX               | UNIT |    |  |
| +         |                  | ٨           | V                      | C <sub>L</sub> = 15 pF |     | 5.1 <sup>(2)</sup> | 8.6 <sup>(2)</sup>       | 1 <sup>(2)</sup> | 10 <sup>(2)</sup> | 1    | 10 |  |
| ۲pd       | A                | Ī           | C <sub>L</sub> = 50 pF |                        | 6.7 | 10.6               | 1                        | 12               | 1                 | 12   | ns |  |

(1) Product Preview

(2) On products compliant to MIL-PRF-38535, this parameter is not production tested.

### NOISE CHARACTERISTICS

 $V_{CC} = 3.3 \text{ V}, \text{ C}_{L} = 50 \text{ pF}, \text{ T}_{A} = 25^{\circ}\text{C}^{(1)}$ 

|                    |                                  | SN74LV14A |      |      | UNIT |
|--------------------|----------------------------------|-----------|------|------|------|
|                    |                                  | MIN       | TYP  | MAX  | UNIT |
| V <sub>OL(P)</sub> | Quiet output, maximum dynamic    |           | 0.2  | 0.8  | V    |
| V <sub>OL(V)</sub> | Quiet output, minimum dynamic    |           | -0.1 | -0.8 | V    |
| V <sub>OH(V)</sub> | Quiet output, minimum dynamic    |           | 3.1  |      | V    |
| V <sub>IH(D)</sub> | High-level dynamic input voltage | 2.31      |      |      | V    |
| V <sub>IL(D)</sub> | Low-level dynamic input voltage  |           |      | 0.99 | V    |

(1) Characteristics are for surface-mount packages only.

### **OPERATING CHARACTERISTICS**

 $T_A = 25^{\circ}C$ 

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|                 | PARAMETER                     | TEST CONDITIONS   | Vcc | TYP | UNIT |
|-----------------|-------------------------------|---|-----|-----|------|
| C               | Dower dissinction conscitutes | capacitance $C_1 = 50 \text{ pF}, \text{ f} = 10 \text{ MHz}$ |     | 8.8 | ъЕ   |
| C <sub>pd</sub> | Power dissipation capacitance | $C_{L} = 50 \text{ pF}, \text{ f} = 10 \text{ MHz}$           | 5 V | 9.6 | pF   |

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IFXAS

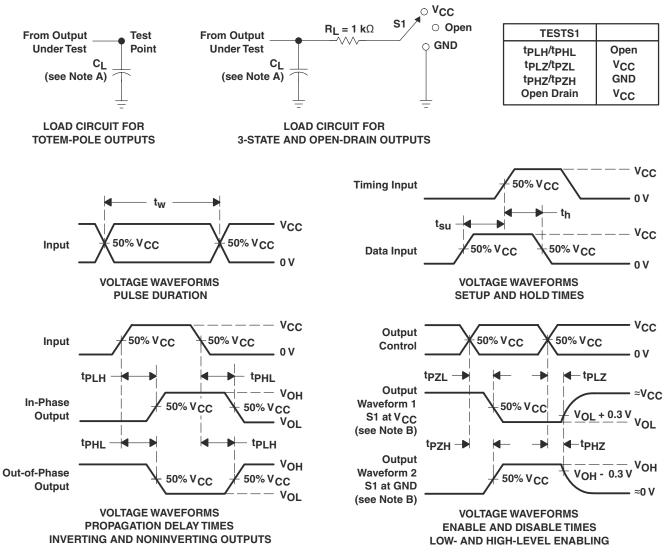
RUMENTS



# SN54LV14A, SN74LV14A HEX SCHMITT-TRIGGER INVERTERS

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### PARAMETER MEASUREMENT INFORMATION



- A. C<sub>L</sub> includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  3 ns, t<sub>f</sub>  $\leq$  3 ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

#### Figure 1. Load Circuit and Voltage Waveforms

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|           | e Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|-----------|----------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| SN74L     | V14AD    | ACTIVE                | SOIC            | D                  | 14   | 50             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV1   | 4ADBLE   | OBSOLETE              | SSOP            | DB                 | 14   |                | TBD                       | Call TI          | Call TI                      |
| SN74LV    | 14ADBR   | ACTIVE                | SSOP            | DB                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV14  | 4ADBRE4  | ACTIVE                | SSOP            | DB                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV14  | 4ADBRG4  | ACTIVE                | SSOP            | DB                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV    | 14ADE4   | ACTIVE                | SOIC            | D                  | 14   | 50             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV    | 14ADG4   | ACTIVE                | SOIC            | D                  | 14   | 50             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV1   | 4ADGVR   | ACTIVE                | TVSOP           | DGV                | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV14  | ADGVRE4  | ACTIVE                | TVSOP           | DGV                | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV14  | ADGVRG4  | ACTIVE                | TVSOP           | DGV                | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV    | /14ADR   | ACTIVE                | SOIC            | D                  | 14   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV1   | 4ADRE4   | ACTIVE                | SOIC            | D                  | 14   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV1   | 4ADRG4   | ACTIVE                | SOIC            | D                  | 14   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV    | 14ANSR   | ACTIVE                | SO              | NS                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV14  | 4ANSRE4  | ACTIVE                | SO              | NS                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV14  | 4ANSRG4  | ACTIVE                | SO              | NS                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV    | 14APW    | ACTIVE                | TSSOP           | PW                 | 14   | 90             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV1   | 4APWE4   | ACTIVE                | TSSOP           | PW                 | 14   | 90             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV1   | 4APWG4   | ACTIVE                | TSSOP           | PW                 | 14   | 90             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV1   | 4APWLE   | OBSOLETE              | TSSOP           | PW                 | 14   |                | TBD                       | Call TI          | Call TI                      |
| SN74LV    | 14APWR   | ACTIVE                | TSSOP           | PW                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV14  | APWRE4   | ACTIVE                | TSSOP           | PW                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV14  | APWRG4   | ACTIVE                | TSSOP           | PW                 | 14   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV    | 14APWT   | ACTIVE                | TSSOP           | PW                 | 14   | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LV14  | 4APWTE4  | ACTIVE                | TSSOP           | PW                 | 14   | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74I V14 | APWTG4   | ACTIVE                | TSSOP           | PW                 | 14   | 250            | Green (RoHS &             | CU NIPDAU        | Level-1-260C-UNLIM           |



| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing |      | ckage<br>Qty | Eco Plan <sup>(2)</sup>    | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|--------------|----------------------------|------------------|------------------------------|
|                  |                       |                 |                    |      |              | no Sb/Br)                  |                  |                              |
| SN74LV14ARGYR    | ACTIVE                | QFN             | RGY                | 14 1 | 000          | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| SN74LV14ARGYRG4  | ACTIVE                | QFN             | RGY                | 14 1 | 000          | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### OTHER QUALIFIED VERSIONS OF SN74LV14A :

Automotive: SN74LV14A-Q1

Enhanced Product: SN74LV14A-EP

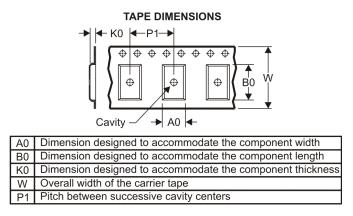
NOTE: Qualified Version Definitions:

- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product Supports Defense, Aerospace and Medical Applications

TEXAS INSTRUMENTS www.ti.com

### TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| Device        | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|---------------|-----------------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74LV14ADBR  | SSOP            | DB                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2     | 6.6     | 2.5     | 12.0       | 16.0      | Q1               |
| SN74LV14ADGVR | TVSOP           | DGV                | 14 | 2000 | 330.0                    | 12.4                     | 6.8     | 4.0     | 1.6     | 8.0        | 12.0      | Q1               |
| SN74LV14ADR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5     | 9.0     | 2.1     | 8.0        | 16.0      | Q1               |
| SN74LV14ADR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5     | 9.0     | 2.1     | 8.0        | 16.0      | Q1               |
| SN74LV14ANSR  | SO              | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2     | 10.5    | 2.5     | 12.0       | 16.0      | Q1               |
| SN74LV14APWR  | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 7.0     | 5.6     | 1.6     | 8.0        | 12.0      | Q1               |
| SN74LV14ARGYR | QFN             | RGY                | 14 | 1000 | 180.0                    | 12.4                     | 3.85    | 3.85    | 1.35    | 8.0        | 12.0      | Q1               |



# PACKAGE MATERIALS INFORMATION

11-Aug-2008



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LV14ADBR  | SSOP         | DB              | 14   | 2000 | 346.0       | 346.0      | 33.0        |
| SN74LV14ADGVR | TVSOP        | DGV             | 14   | 2000 | 346.0       | 346.0      | 29.0        |
| SN74LV14ADR   | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |
| SN74LV14ADR   | SOIC         | D               | 14   | 2500 | 346.0       | 346.0      | 33.0        |
| SN74LV14ANSR  | SO           | NS              | 14   | 2000 | 346.0       | 346.0      | 33.0        |
| SN74LV14APWR  | TSSOP        | PW              | 14   | 2000 | 346.0       | 346.0      | 29.0        |
| SN74LV14ARGYR | QFN          | RGY             | 14   | 1000 | 190.5       | 212.7      | 31.8        |

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

### DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



### PLASTIC SMALL-OUTLINE PACKAGE

### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

# PW (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

### DGV (R-PDSO-G\*\*)

24 PINS SHOWN



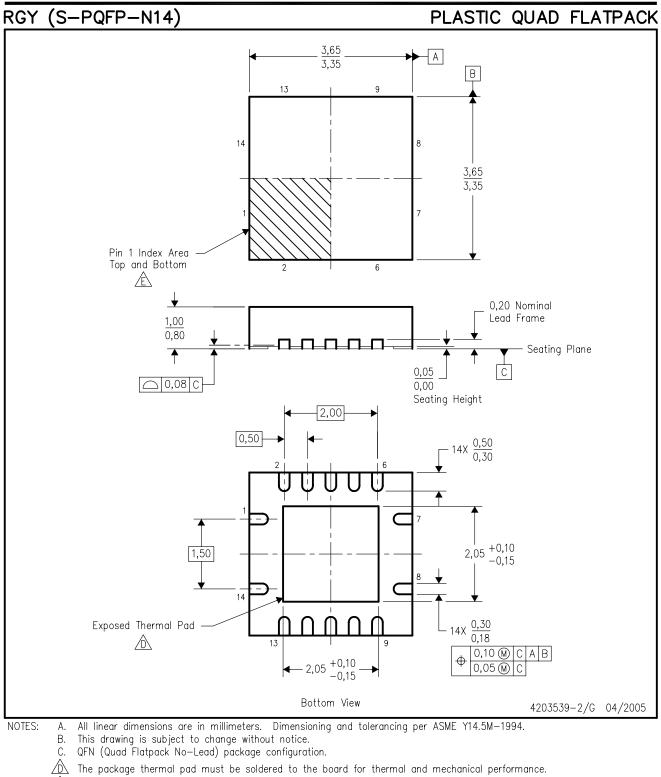
NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194





È Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.

F. Package complies to JEDEC MO-241 variation BA.





# THERMAL PAD MECHANICAL DATA

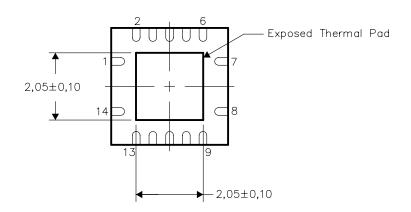
# RGY (S-PQFP-N14)

### THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, Quad Flatpack No-Lead Logic Packages, Texas Instruments Literature No. SCBA017. This document is available at www.ti.com.

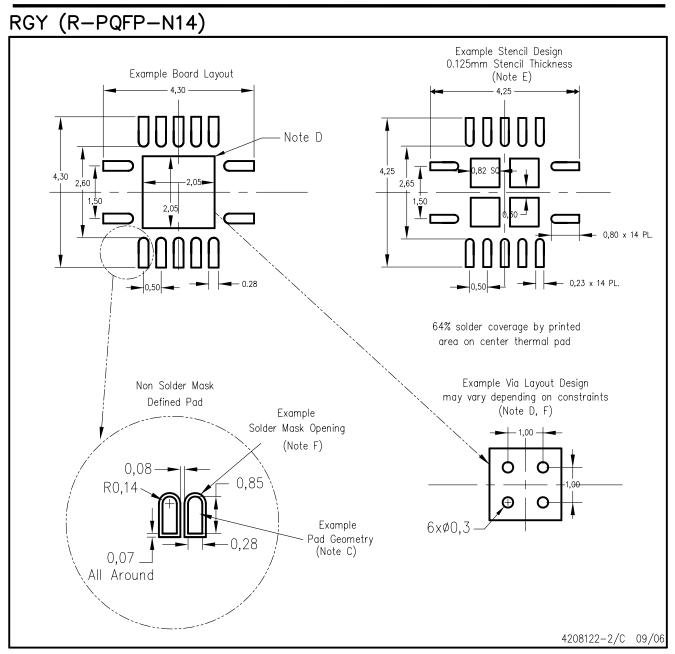
The exposed thermal pad dimensions for this package are shown in the following illustration.





NOTE: All linear dimensions are in millimeters

Exposed Thermal Pad Dimensions



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SCBA017, SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <a href="http://www.ti.com">http://www.ti.com</a>.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.

Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.

E. Reference JEDEC MS-012 variation AB.



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